

Low ON-Resistance, Low Voltage, SPDT Analog Switch

FEATURES

- -3dB Bandwidth: 120MHz
- High Speed, Typically 11ns
- Supply Range: +1.8V to +5.5V
- Low ON-State Resistance, 2.4Ω(TYP)
- Break-Before-Make Switching
- Rail-to-Rail Operation
- TTL/CMOS Compatible
- MicroSIZE PACKAGES:SOT363(SC70-6)
- Extended Industrial Temperature Range: -40°C to +125°C

DESCRIPTION

The RS2101 is a low on-resistance, single-pole double-throw (SPDT) analog switch that is designed to operate from 1.8 V to 5.5 V.

The RS2101 device can handle both analog and digital signals. It features fast switching speeds (ton = 11ns, toFF = 8ns) and low on-resistance (2.4 Ω TYP).

These features make this device suitable for a wide variety of portable applications including cell phones, audio devices, and instrumentation.

APPLICATIONS

- Wearable Devices
- Battery-Operated Equipment
- Signal Gating, Chopping, Modulation or Demodulation (Modem)
- Portable Computing
- Cell Phones

FUNCTION TABLE

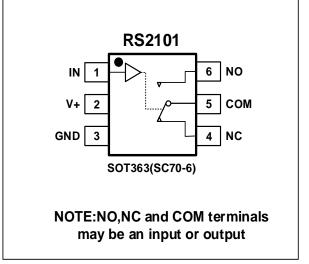
LOGIC	NO	NC
0	OFF	ON
1	ON	OFF

PIN DESCRIPTION

NAME	PIN	FUNCTION	
IN	1	Digital Control Pin	
V+	2	Power Supply	
GND	3	Ground	
NC	4	Normally-Closed Terminal	
COM	5	Common Terminal	
NO	6	Normally-Open Terminal	

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-toanalog conversion systems.

PIN CONFIGURATIONS



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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

V+, IN to GND	0.3V to 6.0V
Analog, Digital Voltage Range (2)	- 0.3 to (V+) + 0.3V
Continuous Current NO, NC, or COM	±300mA
Peak Current NO, NC, or COM	±500mA
Storage Temperature	. −65°C to +150°C
Operating Temperature	−40°C to +125°C
Junction Temperature	
Package Thermal Resistance @ TA = +2	25°C
SC70-6	333°C/W
MSOP-10, SOIC-8 ,TSSOP-8	150°C/W
SOIC-14, TSSOP-14	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
НВМ	1000V
MM	100V

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less.



ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS2101	RS2101XC6	-40°C~125°C	SOT363 (SC70-6)	2101X	Tape and Reel,3000

NOTE: X = Date Code

MARKING INFORMATION





ELECTRICAL CHARACTERISTICS

V+ = 5.0 V, T_{A} = -40°C to 125°C (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	V+	TA	MIN	ТҮР	MAX	UNITS
ANALOG SWITCH		-	-		-	-		
Analog Signal Range	VNO, VNC, VCOM			FULL	0		V+	V
		$0 \leqslant (V_{NO} \text{ or } V_{NC}) \leqslant V+,$ I _{COM} = -10mA, Switch ON, See Figure 1	5)(+25°C		2.4	3.5	Ω
	_		5V	FULL			4.5	Ω
On-Resistance	Ron		0.01/	+25°C		2.8	4.3	Ω
			3.3V	FULL			6	Ω
			+25°C		0.1	0.8	Ω	
On-Resistance Match		$0 \leqslant (V_{NO} \text{ or } V_{NC}) \leqslant V+,$	5V	FULL			0.9	Ω
Between Channels	ΔRon	I _{COM} = -10mA, Switch ON, See Figure 1		+25℃		0.1	0.8	Ω
			3.3V	FULL			0.9	Ω
	Rflat(on)	$0 \leqslant (V_{NO} \text{ or } V_{NC}) \leqslant V+,$ I_{COM} = -10mA, Switch ON, See Figure 1		+25℃		0.7	0.9	Ω
			5V	FULL			0.95	Ω
On-Resistance Flatness				+25°C		0.9	1	Ω
			3.3V	FULL			1.2	Ω
NC,NO OFF Leakage Current	INC(OFF), INO(OFF)	V _{NO} or V _{NC} = 0.3V, V+/2 V _{COM} = V+/2, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μA
NC,NO,COM ON Leakage Current	Inc(on), Ino(on), Icom(on)	V _{NO} or V _{NC} = 0.3V, Open V _{COM} = Open, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μA
DIGITAL CONTROL INP	UTS ⁽¹⁾				1	I		
Input High Voltage	Vinh		5V	FULL	1.5			V
			3.3V	FULL	1			V
	Vinl		5V	FULL			0.6	V
Input Low Voltage			3.3V	FULL			0.5	V
Input Leakage Current	lin	VIN = VIO or 0	1.8 to 5.5V	FULL			1	μA

(1) All unused digital inputs of the device must be held at VIO or GND to ensure proper device operation.



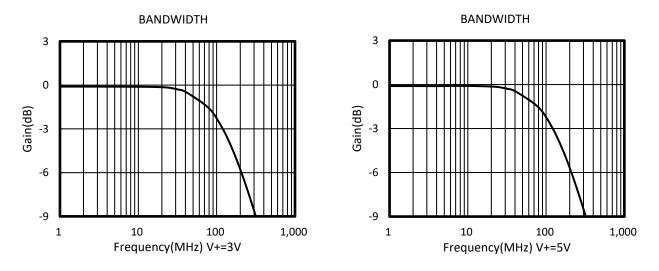
ELECTRICAL CHARACTERISTICS (continued) V+ = 5.0 V, TEMP= -40°C to 125°C (unless otherwise noted))

PARAMETER	SYMBOL	CONDITIONS		V+	TEMP	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERISTICS									
Turn-On Time		$V_{COM} = V_{+}, R_{L} = 300\Omega, C_{L} = 35pF,$		5V	. 05%0		11		
Turn-On Time	ton	See Figure 5		3.3V	+25°C		12		ns
Turn-Off Time	torr	V _{COM} = V+, R _L = 300Ω, C _L = 35pF,		5V	+25°C	8		ns	
	LOFF	See Figure 5		3.3V	+23 0		9		115
Break-Before-Make	tввм	$V_{NO1} = V_{NC1} = V_{NO2} = V$,	5V	+25°C		10		ns
Time Delay	LBBM	$R_L = 300\Omega, C_L = 35pF,$	See Figure 6	3.3V	+23 0		11		
Off Isolation	Oiso	R∟ = 50Ω, Switch OFF, See Figure 8	f = 10MHz		+25°C		-43		dB
			f = 1MHz		+25°C		-67		dB
-3dB Bandwidth	BW	Switch ON, R _L = 50Ω See Figure 7			+25℃		120		MHz
NC,NO OFF Capacitance	CNC(OFF), CNO(OFF)	V _{NC} or V _{NO} =V+/2 or GND, Switch OFF See Figure 4			+25°C		15		pF
NC,NO,COM ON Capacitance	CNC(ON), CNO(ON), CCOM(ON)	V _{NC} or V _{NO} =V+/2 or GND, Switch ON See Figure 4			+25°C		50		pF
POWER REQUIREMENTS									
Power Supply Range	V+				FULL	1.8		5.5	V
Power Supply Current	l+	V_{IN} = GND or V+		5.5V	FULL			1	μA

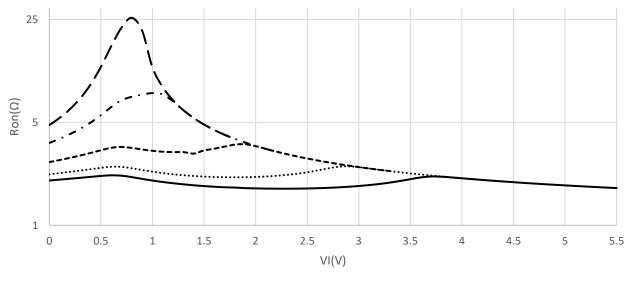


TYPICAL CHARACTERISTICS

V+ = 5.0 V, $T_{\text{A}}\text{=}-40^{\circ}\text{C}$ to 125°C (unless otherwise noted)



Typical ron as a Function of Input Voltage (VI) for VI = 0 to V+





Parameter Measurement Information

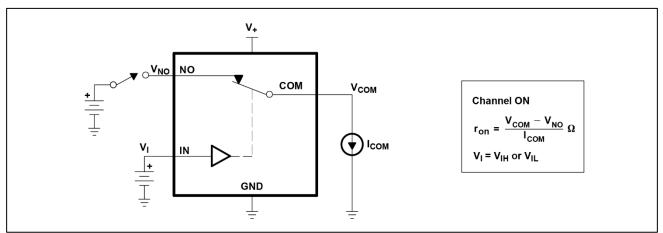


Figure 1.ON-State Resistance (ron)

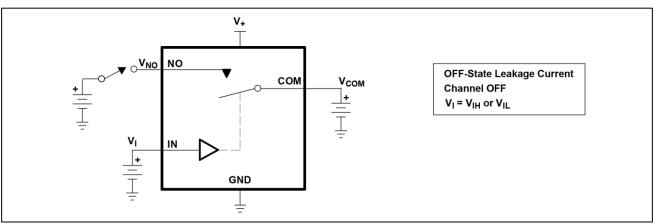


Figure 2.OFF-State Leakage Current (ICOM(OFF), INO(OFF))

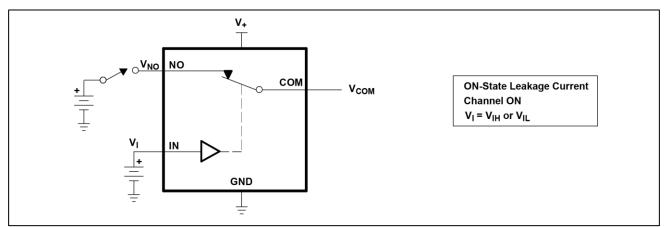


Figure 3.ON-State Leakage Current (ICOM(ON), INO(ON))



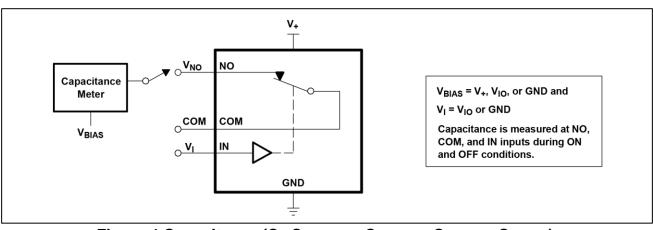


Figure 4.Capacitance (CI, CCOM(OFF), CCOM(ON), CNO(OFF), CNO(ON))

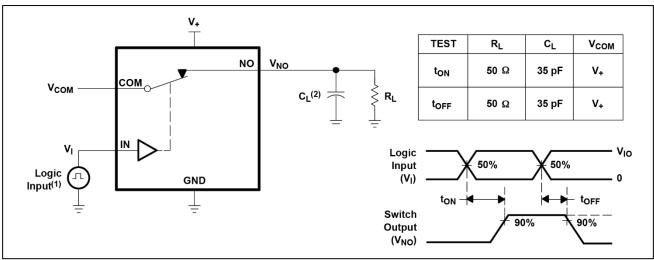


Figure 5.Turn-On (ton) and Turn-Off Time (toff)

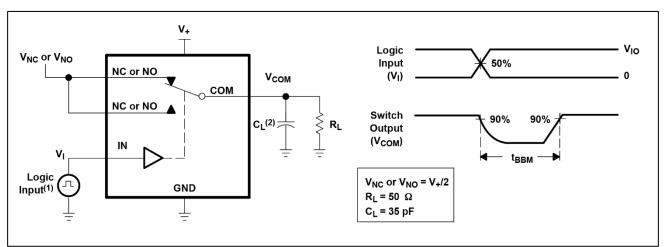


Figure 6.Break-Before-Make Time (t_{BBM})



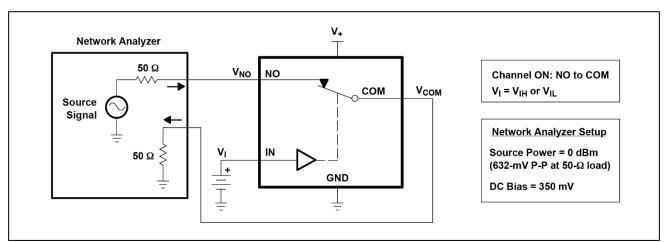


Figure 7.Bandwidth (BW)

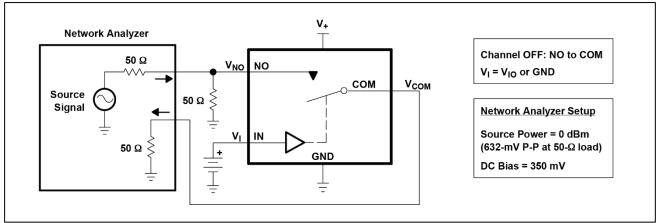


Figure 8.OFF Isolation (O_{ISO})

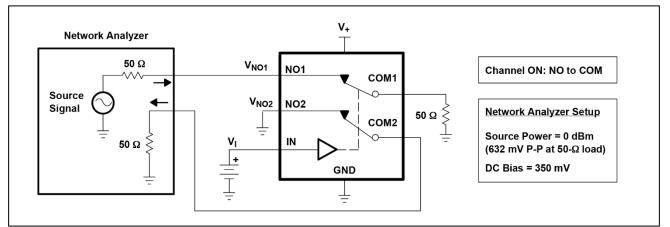


Figure 9.Crosstalk (XTALK)



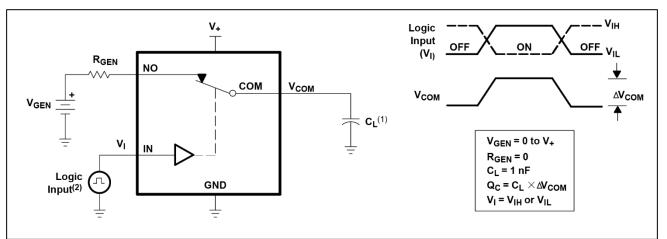


Figure 10.Charge Injection (Qc)

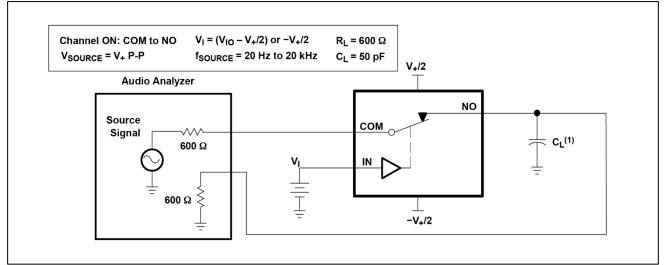
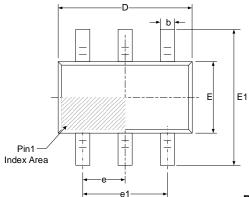
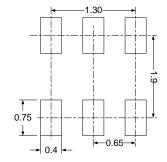


Figure11.Total Harmonic Distortion (THD)

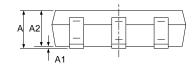


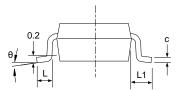
$\begin{array}{l} \mbox{package outline dimensions}\\ SOT363(SC70\mbox{-}6) \end{array}$





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Min Max		Мах		
А	0.900	1.100	0.035	0.043		
A1	0.000	0.100	0.000	0.004		
A2	0.900	1.000	0.035	0.039		
b	0.150	0.350	0.006	0.014		
С	0.080	0.150	0.003	0.006		
D	2.000	2.200	0.079	0.087		
E	1.150	1.350	0.045	0.053		
E1	2.150	2.450	0.085	0.096		
е	0.650	(BSC)	0.026(BSC)			
e1	1.300	1.300(BSC)		(BSC)		
L	0.260	0.460	0.010	0.018		
L1	0.5	525	0.021			
θ	0°	8°	0°	8°		